

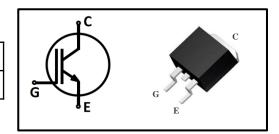
Features

- Easy parallel switching capability due to positive temperature coefficient in V_{CEsat}
- Low V_{CEsat}, fast switching
- High ruggedness, good thermal stability
- Very tight parameter distribution

Туре	Marking	Package Code
MPGC50N65E	MPG50N65E	TO-263

Applications

- UPS
- PFC
- **■** PTC Heater
- Climate Compressor



Maximum Rated Values 1

Parameter	Symbol	Value	Unit		
Collector-emitter voltage	V _{CE}	650	V		
DC collector current ²					
T _C =25°C		80	A		
T _C =100°C	lc	50	A		
Pulsed collector current ³	I _{Cpuls}	300			
Gate-emitter voltage		±20	\ \		
Transient Gate-emitter voltage (t _p ≤10us)	V_{GE}	±30	V		
Power dissipation	Power dissipation				
T _C =25°C	D	300	W		
T _C =100°C	P _{tot}	150			
Operating junction temperature	T _j	-55~175	°C		
Storage temperature	T _{stg}	-55~150			

^{1:}Reference standard: JESD-022 2: limited by Tjmax 3: Tp limited by Tjmax ;

Thermal Characteristics

Parameter	Symbol	Min	Тур	Max	Unit
IGBT thermal resistance, junction-case	R _{thJC}	-	-	TBD	K/W
Thermal Resistance, junction-ambient	R _{thJA}	-	-	TBD	r \/ V V



Electrical Characteristics (at Tj=25°C, unless otherwise specified) Static Characteristics

Parameter	Symbol	Conditions	Min	Тур	Max	Unit	
Collector-emitter breakdown voltage	V _{(BR)CES}	V _{GE} =0V, I _C =0.25mA	650	-	-		
Collector-emitter		V _{GE} =15V, I _C =50A T _j =25°C	-	1.60	1.90		
saturation voltage	V _{CE(sat)}	T _j =125°C	-	1.90	-	V	
		T _j =150°C	-	1.98	-		
G-E threshold voltage	$V_{GE(th)}$	$I_C=1$ mA, $V_{CE}=V_{GE}$	4.5	5.5	6.5		
C-E leakage current	I _{CES}	V _{CE} =650V, V _{GE} =0V T _j =25°C	-	-	0.01	mA	
		T _j =150°C	-	-	1.0		
G-E leakage current	I _{GES}	$V_{CE}=0V$, $V_{GE}=20V$	-	-	250	nA	
Transconductance	g _{FS}	V_{CE} =20V, I_{C} =50A	-	21	-	S	

Dynamic Characteristics

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Input capacitance	C _{iss}	\/ _25\/	-	5573	1	
Output capacitance	C _{oss}	V _{CE} =25V, V _{GE} =0V, f=1MHz	1	175	ı	pF
Reverse transfer capacitance	C _{rss}	f=1MHz	-	80	-	•
Gate charge	Q_{G}	V _{CC} =300V, I _C =50A, V _{GE} =15V	-	230	-	nC



IGBT Switching Characteristics

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Turn-on delay time	t _{d(on)}	T_25°C	-	89	-	
Rise time	t _r	T _j =25°C, V _{CC} =400V,	-	62	-	
Turn-off delay time	t _{d(off)}	I _C =50A,	-	265	-	ns
Fall time	t _f	$V_{GE}=0/15V$, $R_{G}=10\Omega$,	-	47	-	
Turn-on energy	E _{on}	Diode from	-	1.22	-	
Turn-off energy	E _{off}	MPBW50N65E	-	1.20	-	mJ
Total switching energy	E _{ts}	Inductive load	-	2.42	-	
Turn-on delay time	t _{d(on)}	T_150°C	-	91	-	
Rise time	t _r	T _j =150°C, V _{CC} =400V,	-	63	-	
Turn-off delay time	t _{d(off)}	I _C =50A,	_	302	-	ns
Fall time	t _f	$V_{GE}=0/15V$, $R_{G}=10\Omega$,	-	55	-	
Turn-on energy	E _{on}	Diode from	-	2.24	-	
Turn-off energy	E _{off}	MPBW50N65E	-	1.50	-	mJ
Total switching energy	E _{ts}	Inductive load	-	3.74	-	



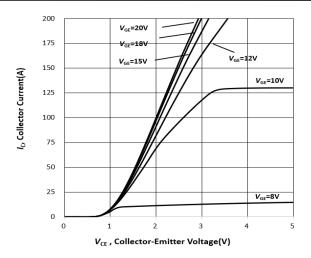


Figure 1. Typical output characteristic $(T_i = 25 \degree C)$

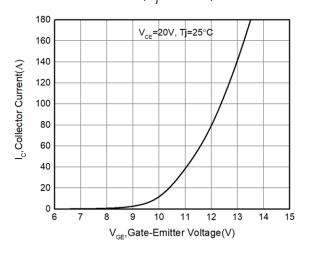


Figure 3. Typical transfer characteristic $(T_i = 25 \, ^{\circ}\text{C})$

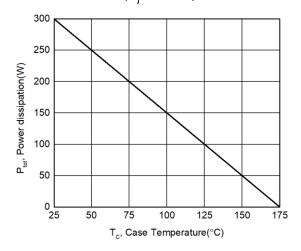


Figure 5. Power dissipation as a function of case temperature $(T_i \le 175 \degree C)$

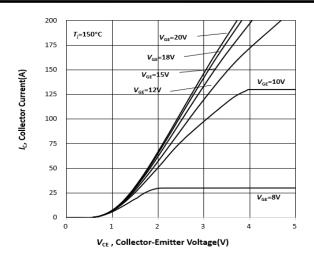


Figure 2. Typical output characteristic $(T_i = 150 \, ^{\circ}\text{C})$

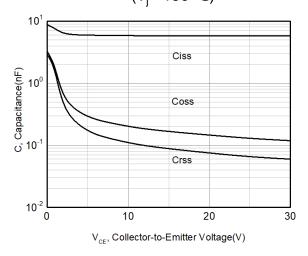


Figure 4. Capacitance characteristic $(V_{GF}=0V, f=1MHz)$

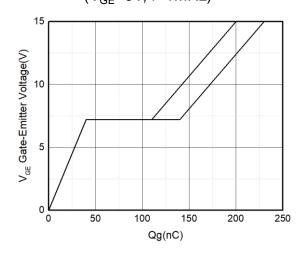


Figure 6. Typical gate charge ($I_{\rm C}$ =50A)



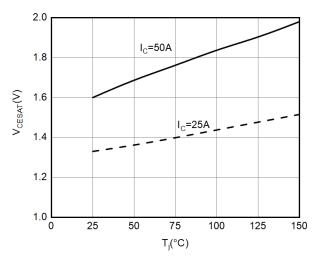


Figure 7. V_{CESAT} as a function of junction temperature (V_{GE} =15V)

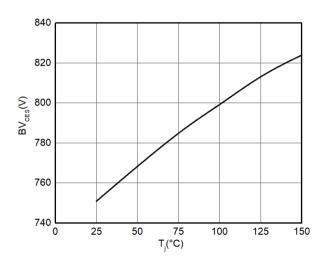


Figure 9. BV as a function of junction temperature (I_{CE} =250µA)

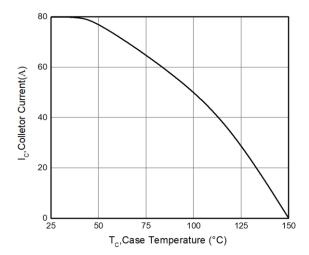


Figure 11. Collector current as a function of case temperature $(V_{GE} \ge 15V, T_i \le 150 \degree C)$

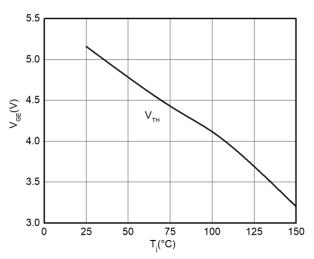


Figure 8. V_{TH} as a function of junction temperature (I_{CE} =250 μ A)

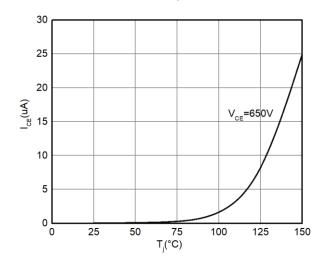


Figure 10. I_{CES} leakage current as a function of junction temperature

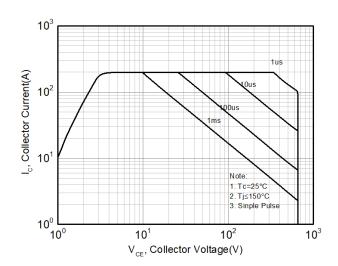


Figure 12. FBSOA



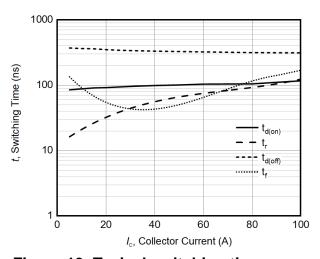


Figure 13. Typical switching times as a function of collector current (T_i =150 °C, V_{CE} =400V, $R_{G(on)}$ = $R_{G(off)}$ =10 Ω)

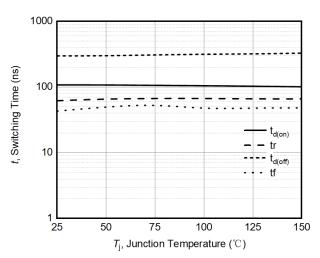


Figure 15. Typical switching times as a function of junction temperature ($V_{\rm CE}$ =400V, $I_{\rm C}$ =50A, $R_{\rm G(on)}$ = $R_{\rm G(off)}$ =10 Ω)

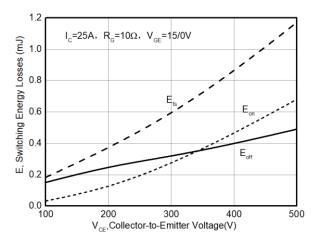


Figure 17. E_{on} , E_{off} as a function of V_{CE} $(T_j=25~{}^{\circ}C)$

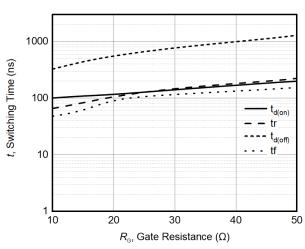


Figure 14. Typical switching times as a function of gate resistance (T_i =150 °C, V_{CE} =400V, I_{C} =50A)

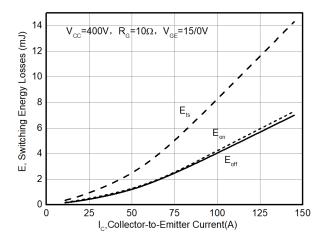


Figure 16. E_{on} , E_{off} as a function of I_{C} $(T_{i}=25~^{\circ}C)$

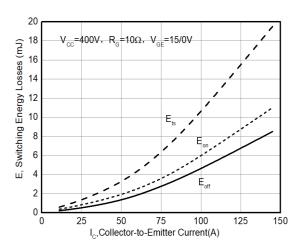


Figure 18. E_{on} , E_{off} as a function of I_{C} (T_{i} =150 °C)



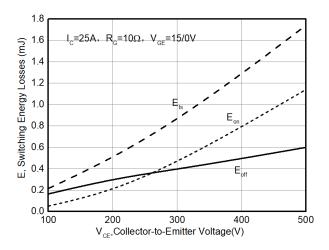


Figure 19. $E_{\rm on,}$ $E_{\rm off}$ as a function of $V_{\rm CE}$ $(T_{\rm j}{=}150~{\rm ^{\circ}C})$

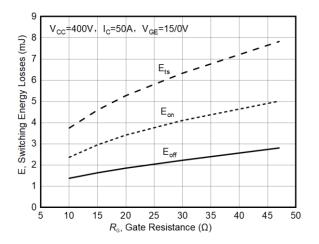


Figure 21. $E_{on,}$ E_{off} as a function of gate resistance (T_{j} =150 °C)

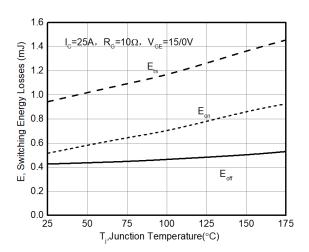
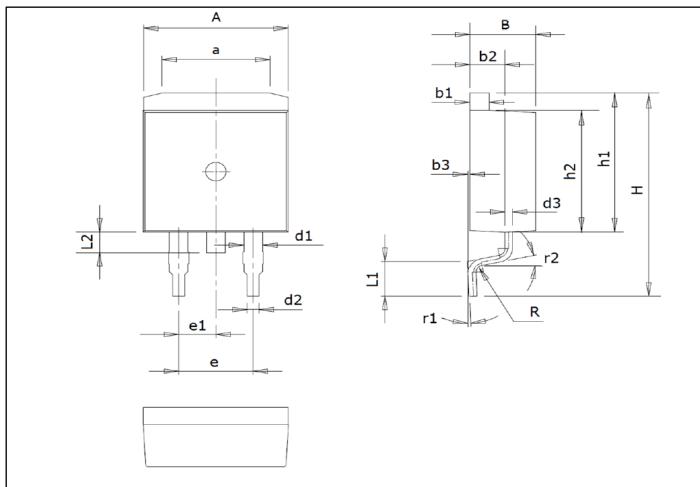


Figure 20. $E_{\rm on,}$ $E_{\rm off}$ as a function of junction temperature



TO-263



Symbol	Dimensions (mm)	Symbol	Dimensions (mm)	Symbol	Dimensions (mm)
Α	9.86~10.26	d2	0.7~0.96	L1	2.0~2.6
а	7.0~7.8	d3	0.3~0.53	L2	1.3~1.8
В	4.37~4.77	е	5.08	R	0.5
b1	1.22~1.42	e1	2.54	r1	0-9°
b2	2.2~2.6	Н	14.7~15.5	r2	12°
b3	0~0.25	h1	10.3~10.7		
d1	1.17~1.47	h2	9.1~9.4		



Revision History:

Revision	Date	Subjects (major changes since last revision)
1.0	2023-02-16	Initial Version



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